



3.2 mm x 5 mm Ceramic Package SMD Oscillator, TTL / HC-MOS



ISM92 Series

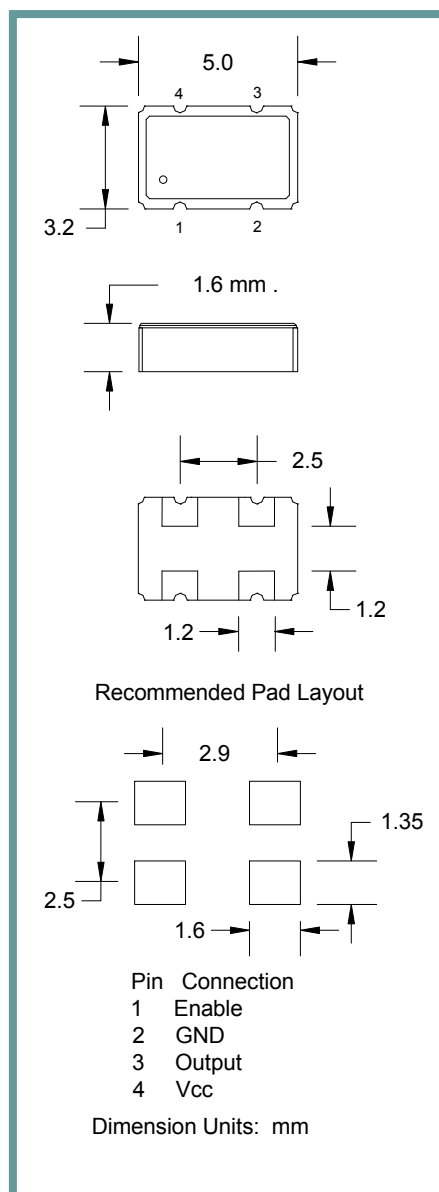
Product Features:

Low Jitter, Non-PLL Based Output
CMOS/TTL Compatible Logic Levels
Compatible with Leadfree Processing

Applications:

Fibre Channel
Server & Storage
Sonet /SDH
802.11 / Wifi
T1/E1, T3/E3
System Clock

Frequency	1.5 MHz to 125.000 MHz
Output Level HC-MOS TTL	'0' = 0.1 Vcc Max., '1' = 0.9 Vcc Min. '0' = 0.4 VDC Max., '1' = 2.4 VDC Min.
Duty Cycle	Specify 50% $\pm$ 10% or $\pm$ 5% See Table in Part Number Guide
Rise / Fall Time	5 nS Max. @ Vcc = +3.3 VDC, 10 nS Max. @ Vcc = +5 VDC ***
Output Load	Fo < 50 MHz = 10 TTL, Fo > 50 MHz = 5 LSTTL See Table in Part Number Guide
Frequency Stability	See Frequency Stability Table (Includes room temperature tolerance and stability over operating temperature)
Start-up Time	10 mS Max.
Enable / Disable Time	100 nS Max. N.C. or $\geq$ 70% Vdd = Enable. $\leq$ 30% Vdd = Disable.
Supply Voltage	See Input Voltage Table, tolerance $\pm$ 5 %
Current	40 mA Max. ***
Operating	See Operating Temperature Table in Part Number Guide
Storage	-55° C to +125° C
Jitter: RMS(1sigma) 1 MHz-75 MHz 76 MHz-80 MHz	5 pS RMS (1 sigma) Max. accumulated jitter (20K adjacent periods) 3 pS RMS (1 sigma) Max. accumulated jitter (20K adjacent periods)
Max Integrated 1 MHz-75 MHz 76 MHz-80 MHz	1.5 pS RMS (1 sigma -12KHz to 20MHz) 1 pS RMS (1 sigma -12KHz to 20MHz)
Max Total Jitter 1 MHz-75 MHz 76 MHz-80 MHz	50 pS p-p (100K adjacent periods) 30 pS p-p (100K adjacent periods)



Part Number Guide		Sample Part Number: ISM92 - 3251BH - 20.000					
Package	Input Voltage	Operating Temperature	Symmetry (Duty Cycle)	Output	Stability (in ppm)	Enable / Disable	Frequency
ISM92 -	5 = 5.0 V	1 = 0° C to +70° C	5 = 45 / 55 Max.	1 = 10TTL / 15 pF HC-MOS	**E = $\pm$ 10	H = Enable	- 20.000 MHz
	3 = 3.3 V	6 = -10° C to +70° C	6 = 40 / 60 Max.	6 = 30 pF	**D = $\pm$ 15	O = N/C	
	7 = 3.0 V	3 = -20° C to +70° C		5 = 50 pF HC-MOS (<40 MHz)	**F = $\pm$ 20		
	2 = 2.7 V	4 = -30° C to +75° C			**A = $\pm$ 25		
	6 = 2.5 V	2 = -40° C to +85° C			B = $\pm$ 50		
	1 = 1.8 V*				C = $\pm$ 100		

NOTE: A 0.01 μ F bypass capacitor is recommended between Vcc (pin 4) and GND (pin 2) to minimize power supply noise.

* Not available at all frequencies. ** Not available for all temperature ranges. *** Frequency, supply, and load related parameters.



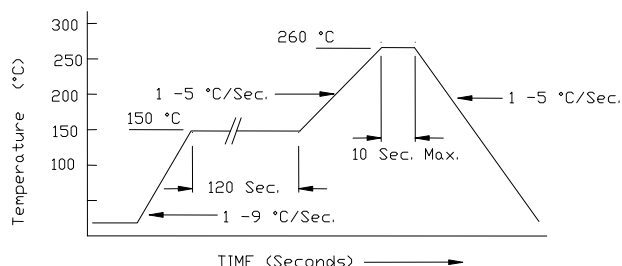
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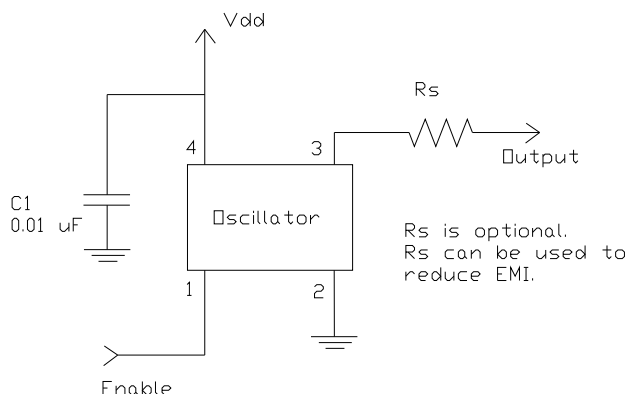
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Pb Free Solder Reflow Profile:

Typical Application:



*Units are backward compatible with 240C reflow processes

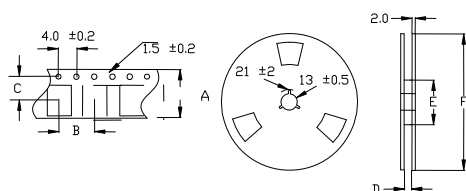


Package Information:

MSL = N.A. (package does not contain plastic, storage life is unlimited under normal room conditions).

Termination = e4 (Au over Ni over W base metalization).

Tape and Reel Information:



Quantity per Reel	1000
A	16 +/- .3
B	8 +/- .2
C	7.5 +/- .2
D	17.5 +/- .1
E	50 / 60 / 80
F	180 / 250

Environmental Specifications

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, $R_1=2 \times 10^{-8}$ atm cc/s
Solvent Resistance	MIL-STD-202, Method 215

Marking

Line 1: ILSI and Date Code (YWW)

Line 2: Frequency